1241152-5 ACTIVE

AMPMODU | AMPMODU HV-100/HV-190

TE Internal #: 1241152-5

PCB Mount Receptacle, Vertical, Board-to-Board, 5 Position, .1 in

[2.54 mm] Centerline, Gold, Surface Mount, Signal, Black,

AMPMODU HV-100/HV-190

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 5
Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	5
Number of Rows	1
Board-to-Board Configuration	Parallel

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Contact Layout	Inline
Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.5 µm



Mating Pin Diameter	.63 mm[.025 in]
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	3 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.7 mm[.027 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Bottom & Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP (Liquid Crystal Polymer)
Dimensions	
Connector Height	6.2 mm[.244 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	9 mm[.354 in]
PCB Thickness (Recommended)	1.4 – 2.4 mm[.055 – .094 in]
Usage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Reel



Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts













TE Part # 826631-5 5P AMPMODU II STIFT LEI



TE Part # 826646-5 5P AMPMODU II STIFT LEI



TE Part # 826651-5 5P AMPMODU II STIFT LEI





TE Part # 826654-5 5P AMPMODU II STIFT LEI



Also in the Series | AMPMODU HV-100/HV-190



PCB Headers & Receptacles(349)

Customers Also Bought



TE Part #7-338069-6 MICRO-MATCH SMD FTE



TE Part #5050871-6 SOCKET,MIN-SPR W/H SN SER-5



TE Part #1551576-5 Shield Finger, 3.4mm



TE Part #1551575-5 Shield Finger, Loose Piece





TE Part #6-1624108-8 3640 0402 15nH 2% 1K RL



CPF0603 100K 0.1% 25PPM 1K RL







Documents

Product Drawings

5P HV100 REC. CON, SMD, GOLD, BLISTER

English

CAD Files

Customer View Model

ENG_CVM_CVM_1241152-5_D.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1241152-5_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1241152-5_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1773393_ AMPMODU_EUROPEAN_STANDARD_PRODUCTS

English